



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#2
8-30-08

Applicant: John Hsieh et al.

Title: Removal of Enclosed Glass Parts After Cutting Using Heating and Cooling Techniques

Assignee: Komag, Inc.

Serial No.: 09/558,083

Filing Date: 4/25/00

Examiner: Unknown

Art Unit: 1731

Docket: K2000003 US

Assistant Commissioner for Patents
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Applicant brings to the Examiner's attention Japanese laid-open publications 2-92837 and 7-223828. These references are discussed in the present application.

Translations of these references are included herewith, along with a PTO form 1449.

Nothing in this Information Disclosure Statement should be construed as a representation that either of these references is material to the present Application.

Respectfully submitted,

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TO 1700 MAIL ROOM

AUG 30 2000

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on August 19, 2000

8/19/00
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